# TinyLogic HST 2-Input NOR Gate

# NC7ST02

## Description

The NC7ST02 is a single 2–Input high performance CMOS NOR Gate, with TTL–compatible inputs. Advanced Silicon Gate CMOS fabrication assures high speed and low power circuit operation. ESD protection diodes inherently guard both inputs and output with respect to the V<sub>CC</sub> and GND rails. High gain circuitry offers high noise immunity and reduced sensitivity to input edge rate. The TTL–compatible inputs facilitate TTL to NMOS / CMOS interfacing. Device performance is similar to MM74HCT but with  $1/_2$  the output current drive of HC / HCT.

#### Features

- Space Saving SC-74A and SC-88A 5-Lead Package
- Ultra Small MicroPak<sup>TM</sup> Leadless Package
- High Speed:  $t_{PD} < 7$  ns Typ,  $V_{CC} = 5$  V,  $C_L = 15$  pF
- Low Quiescent Power:  $I_{CC} < 1 \mu A$  Typ,  $V_{CC} = 5.5 V$
- Balanced Output Drive: 2 mA I<sub>OL</sub>, -2 mA I<sub>OH</sub>
- TTL-compatible Inputs
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

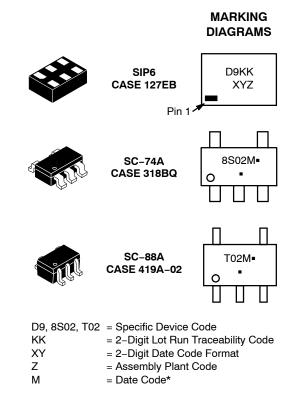


Figure 1. Logic Symbol



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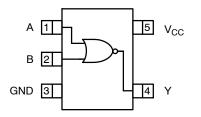


\*Date Code orientation and/or position may vary depending upon manufacturing location.

## **ORDERING INFORMATION**

See detailed ordering, marking and shipping information in the package dimensions section on page 4 of this data sheet.

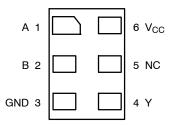
## **Pin Configurations**



#### Figure 2. SC-88A and SC-74A (Top View)

#### **PIN DESCRIPTIONS**

Pin Name	Description
A, B	Inputs
Y	Output
NC	No Connect



#### Figure 3. MicroPak (Top Through View)

## **FUNCTION TABLE** $(Y = \overline{A + B})$

Inp	Output	
А	В	Y
L	L	Н
L	Н	L
Н	L	L
Н	Н	L

H = HIGH Logic Level L = LOW Logic Level

#### **ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter		Min	Мах	Unit
V <sub>CC</sub>	Supply Voltage		-0.5	6.5	V
I <sub>IK</sub>	DC Input Diode Current V <sub>IN</sub> < 0 V		-	-20	mA
		$V_{IN} > V_{CC}$	-	+20	
V <sub>IN</sub>	DC Input Voltage		-0.5	V <sub>CC</sub> + 0.5	V
I <sub>OK</sub>	DC Output Diode Current	V <sub>OUT</sub> < 0 V	-	-20	mA
		$V_{OUT} > V_{CC}$	-	+20	
V <sub>OUT</sub>	Output Voltage		-0.5	V <sub>CC</sub> + 0.5	V
I <sub>OUT</sub>	DC Output Source or Sink Current		-	±12.5	mA
$I_{CC} \text{ or } I_{GND}$	DC V <sub>CC</sub> or Ground Current per Supply Pin		-	±25	mA
T <sub>STG</sub>	Storage Temperature		-65	+150	°C
TJ	Junction Temperature		-	+150	°C
ΤL	Lead Temperature (Soldering, 10 Seconds)		-	+260	°C
P <sub>D</sub> Pow	Power Dissipation in Still Air	SC-74A	-	390	mW
		SC-88A	-	332	1
		MicroPak-6	-	812	1

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### **RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	Supply Voltage		4.5	5.5	V
VI	Input Voltage		0	V <sub>CC</sub>	V
Vo	Output Voltage		0	V <sub>CC</sub>	V
T <sub>A</sub>	Operating Temperature		-40	+85	°C
t <sub>r</sub> , t <sub>f</sub>	Input Rise and Fall Time	V <sub>CC</sub> = 5.0 V	0	10	ns/V
$\theta_{JA}$	Thermal Resistance	SC-74A	-	320	°C/W
		SC-88A	-	377	
		MicroPak-6	-	154	

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

1. Unused inputs must be held HIGH or LOW. They may not float.

#### DC ELECTICAL CHARACTERISTICS

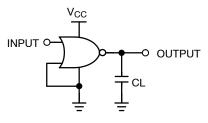
				T <sub>A</sub> = +25°C		;	$T_A = -40$ to $+85^{\circ}C$		
Symbol	Parameter	V <sub>CC</sub> (V)	Conditions	Min	Тур	Max	Min	Max	Unit
VIH	HIGH Level Input Voltage	4.5 – 5.5		2.0	-	-	2.0	-	V
V <sub>IL</sub>	LOW Level Input Voltage	4.5 – 5.5		-	-	0.8	-	0.8	V
V <sub>OH</sub>	HIGH Level Output Voltage	4.5 4.5	$I_{OH} = -20 \ \mu A$ $V_{IN} = V_{IH} \text{ or } V_{IL}$ $I_{OH} = -2 \ m A$	4.4 4.18	4.5 4.35	-	4.4 4.13	-	V
V <sub>OL</sub>	LOW Level Output Voltage	4.5 4.5	$\begin{split} I_{OL} &= 20 \; \mu A \\ V_{IN} &= V_{IH} \; \text{or} \; V_{IL} \\ I_{OL} &= 2 \; m A \end{split}$	-	0 0.10	0.1 0.26	_	0.1 0.33	V
I <sub>IN</sub>	Input Leakage Current	5.5	$0V \leq V_{IN} \leq 5.5 \ V$	-	-	±0.1	-	±1.0	μA
I <sub>CC</sub>	Quiescent Supply Current	5.5	$V_{IN} = V_{CC}$ or GND	-	-	1.0	-	10.0	μA
I <sub>CCT</sub>	I <sub>CC</sub> per Input	5.5	One Input $V_{IN} = 0.5 \text{ V or}$ 2.4 V, Other Input $V_{CC}$ or GND	_	_	2.0	_	2.9	mA

#### AC ELECTRICAL CHARACTERISTICS

				-	T <sub>A</sub> = +25°C		T <sub>A</sub> = -40	to +85°C	
Symbol	Parameter	V <sub>CC</sub> (V)	Conditions	Min	Тур	Max	Min	Max	Unit
t <sub>PLH</sub> , t <sub>PHL</sub>	Propagation Delay (Figure 4, 6)	5.0	C <sub>L</sub> = 15 pF	-	3.5	12	-	-	ns
				-	6.3	17	-	-	
		4.5	C <sub>L</sub> = 50 pF	-	6.1	16	-	20	
				-	11.7	27	-	31	
		5.5		-	4.2	14	-	18	
				-	11.4	26	-	30	
t <sub>TLH</sub> , t <sub>THL</sub>	Output Transition Time	5.0	C <sub>L</sub> = 15 pF	-	4	10	-	-	ns
	(Figure 4, 6)	4.5	C <sub>L</sub> = 50 pF	-	11	25	-	31	
		5.5		-	10	21	-	26	
C <sub>IN</sub>	Input Capacitance	Open		-	2	10	-	-	pF
C <sub>PD</sub>	Power Dissipation Capacitance (Figure 5)	5.0	(Note 2)	_	6	_	-	-	pF

C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current. Current consumption (I<sub>CCD</sub>) at no output loading and operating at 50% duty cycle. (See Figure 5).C<sub>PD</sub> is related to I<sub>CCD</sub> dynamic operating current by the expression: I<sub>CCD</sub> = (C<sub>PD</sub>) (V<sub>CC</sub>) (f<sub>IN</sub>) + (I<sub>CCStatic</sub>).

#### AC Loading and Waveforms



 $C_L$  includes load and stray capacitance Input PRR = 1.0 MHz;  $t_W$  = 500 ns

#### Figure 4. AC Test Circuit

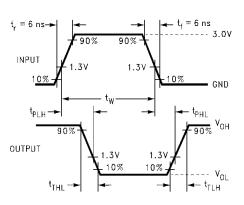
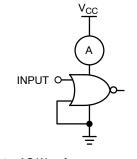


Figure 6. AC Waveforms



Input = AC Waveform; PRR = Variable; Duty Cycle = 50%.

#### Figure 5. I<sub>CCD</sub> Test Circuit

#### **ORDERING INFORMATION**

Order Number	Top Mark	Package Description	Shipping <sup>†</sup>
NC7ST02M5X	8S02	SC-74A	3000 / Tape & Reel
NC7ST02P5X	T02	SC-88A	3000 / Tape & Reel
NC7ST02L6X	D9	SIP6, MicroPak	5000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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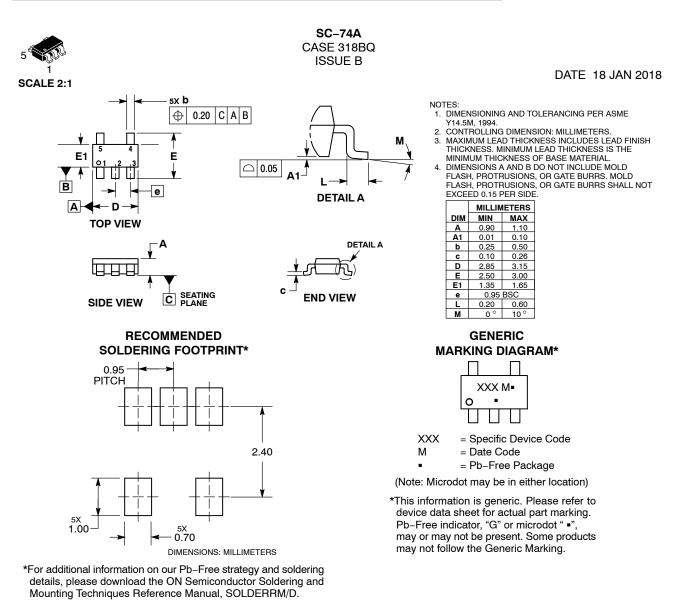


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